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2PS18012E44G40113



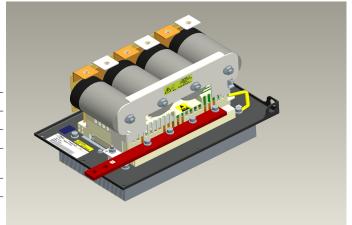
Preliminary data

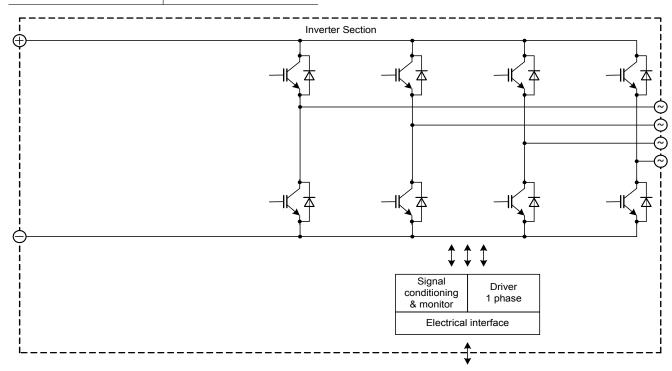
General information

IGBT Stack for typical voltages of up to 400 V_{RMS} Rated output current 770 A_{RMS}

- · Solar power · Motor drives
- · High power converter
- $\begin{array}{l} \cdot \ 62mm \ power \ module \\ \cdot \ Trenchstop^{\text{TM}} \ IGBT4 \end{array}$

Topology	1/2 B2I
Application	Inverter
Load type	Resistive, inductive
Semiconductor (Inverter Section)	4x FF450R12KE4
DC Link	1.6 mF
Heatsink	Forced air cooled (fan not included)
Implemented sensors	Current,voltage, temperature
Driver signals IGBT	Electrical
Approvals	UL 508C
Sales - name	2PS18012E4FG40113
SP - No.	SP001178324





рі	repared by: OW	date of publication: 2014-11-20
a	pproved by: YZ	revision: 2.0

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Absolute maximum rated values

Collector-emitter voltage	IGBT; T _{vj} = 25°C	V _{CES}	1200	V
Repetitive peak reverse voltage	Diode; T _{vj} = 25°C	V_{RRM}	1200	V
DC link voltage		V_{DC}	1000	V
Insulation management	according to installation height of 2000 m	V_{line}	500	V _{RMS}
Insulation test voltage	according to EN 50178, f = 50 Hz, t = 1 s	V_{ISOL}	2.5	kV _{RMS}
Repetitive peak collector current inverter section (IGBT)	$t_p = 1 \text{ ms}$	I _{CRM2}	2560	A
Repetitive peak forward current inverter section (Diode)	$t_p = 1 \text{ ms}$	I _{FRM2}	2440	А
Continuous current inverter section		I _{AC2}	820	A _{RMS}
Junction temperature	under switching conditions	T_{vjop}	150	°C
Switching frequency inverter section	limited due to snubber caps	f _{sw2}	3	kHz

Notes

Further maximum ratings are specified in the following dedicated sections

Characteristic values

DC Link			min.	typ.	max.	
Rated voltage		V _{DC}		650	1000	V
Over voltage shutdown	within 600 μs			1050		V
Capacitor	1 s, 4 p, rated tol. 10 %	C _{DC}		1.6		mF
Maximum ripple current	per device, T _{amb} = 55 °C	I _{ripple}			49	A _{RMS}

Notes
Activ clamping diodes not implemented, max. DC link voltage for short circuit protection 500V Max. DC link voltage under switching conditions 1000V up to 300A (T junction > 25°C)

Inverter Section			min.	typ.	max.	
Rated continuous current	$\begin{array}{l} V_{DC} = 650 \text{ V}, \text{ V}_{AC} = 400 \text{ V}_{RMS}, \cos(\phi) = 0.85, \\ f_{AC \text{ sine}} = 50 \text{ Hz}, f_{sw} = 3000 \text{ Hz}, T_{inlet} = 50 ^{\circ}\text{C}, T_{j} \leq 125 ^{\circ}\text{C} \end{array}$	I _{AC}		770		A _{RMS}
Rated continuous current for 150% overload capability	$I_{AC\ 150\%}$ = 820 A_{RMS} , $t_{on\ over}$ = 60 s, $T_{j} \le 125\ ^{\circ}C$	I _{AC over1}			550	A _{RMS}
Rated continuous current for 150% overload capability	$I_{AC\ 150\%}$ = 820 A _{RMS} , $t_{on\ over}$ = 3 s, $T_{j} \le$ 125 °C	I _{AC over2}			630	A _{RMS}
Over current shutdown	within 15 μs	I _{AC OC}		1280		A _{peak}
Power losses	$ \begin{vmatrix} I_{AC} = 400 \text{ A, } V_{DC} = 650 \text{ V, } \cos(\phi) = 0.85, f_{AC \text{ sine}} = 50 \text{ Hz,} \\ f_{sw} = 3000 \text{ Hz, } T_{inlet} = 50 \text{ °C, } T_{j} \leq 125 \text{ °C} \\ \end{vmatrix} $	P _{loss}		5600		W

Notes

Maximum junction temperature limited to 125°C under all operating conditions

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Controller interface

Driver and interface board	ref. to separate Application Note			DR240		
			min.	typ.	max.	
Auxiliary voltage		V _{aux}	18	24	30	V
Auxiliary power requirement	V _{aux} = 24 V	Paux			40	W
Digital input level	resistor to GND 10 kΩ, capacitor to GND 1 nF	V _{in low}	0		4	V
		V _{in high}	11		15	V
Digital output level	open collector, logic low = no fault, max. 15 mA	V _{out low}	0		1.5	V
		V _{out high}		15		V
Analog current sensor output inverter section	load max 5 mA, @ 770 A _{RMS}	V _{IU} ana2 V _{IV} ana2 V _{IW} ana2	6	6.1	6.2	V
Analog DC link voltage sensor output	load max 5 mA, @ 650 V	V _{DC} ana	5.4	5.5	5.6	V
Over temperature shutdown inverter section	load max 5 mA, @T _{NTC} = 86 °C	V _{Error OT2}	10.8	11	11.2	V

System data

System data				mın.	typ.	max.	
EMC robustness	according to IEC 61800-3 at named	power	V_{Burst}		2		kV
	interfaces	control	V_{Burst}		1		kV
		aux (24V)	V_{surge}		1		kV
Storage temperature			T _{stor}	-40		80	°C
Operational ambient temperature	PCB, DC link capacitor, bus bar, excludi medium	PCB, DC link capacitor, bus bar, excluding cooling medium		-25		60	°C
Cooling air velocity	PCB, DC link capacitor, bus bar, standard atmosphere		V _{air}	2			m/s
Humidity	no condensation	no condensation		0		85	%
Vibration	according to IEC 60721	according to IEC 60721				5	m/s²
Shock	according to IEC 60721					50	m/s²
Protection degree					IP00		
Pollution degree					2		
Dimensions	width x depth x height			284	472	287	mm
Weight					19		kg

Notes

System data valid for continuous operation

Heatsink air cooled min. max. typ. T_{air} = 20 °C, P_{air} = 1013 hPa, dry and dust free, measured at the side of the heat sink according to DIN 41882 Air flow $\Delta V/\Delta t$ 500 m³/h Air pressure drop at min. air flow Δр 200 Pa -30 °C Air inlet temperature $T_{\text{inlet}} \\$

Notes

Conditions are standard Infineon characterization for heatsinks.

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Overview of optional components	Unit 1	Inverter Section	Unit 3
Parallel interface board			
Optical interface board			
Voltage sensor		×	
Current sensor		×	
Temperature sensor		×	
Temperature simulation			
DC link capacitors		×	
Data cable for control signals			
Fan			
Collector-emitter Active Clamping			
Snubber capcitors		×	

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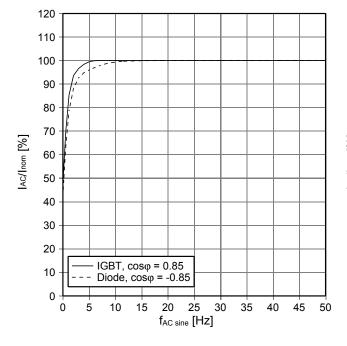
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 $f_{AC~sine}$ - derating curve IGBT (motor), Diode (generator) V_{DC} = 650 V, V_{AC} = 400 $V_{RMS},\,f_{sw}$ = 3 kHz, $cos\phi$ = $\pm0.85,\,$ T_{inlet} = 50 °C and nom. cooling conditions

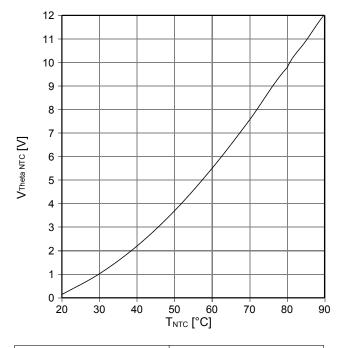
$$\begin{split} &T_{\text{inlet}} \text{- derating curve IGBT (motor), Diode (generator)} \\ &V_{\text{DC}} = 650 \text{ V, V}_{\text{AC}} = 400 \text{ V}_{\text{RMS}}, f_{\text{AC sine}} = 50 \text{ Hz, cos} \phi = \pm 0.85, \\ &T_{\text{inlet}} = 50 \text{ °C and nom. cooling conditions} \end{split}$$

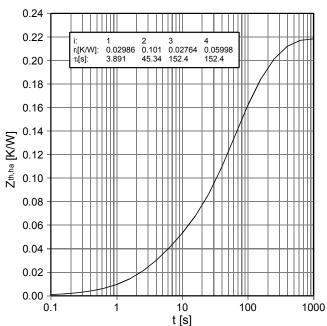


100 90 80 70 AC/Inom [%] 60 50 40 30 20 IGBT, $\cos \varphi = 0.85 \ (100\% = 770A)$ 10 Diode, $\cos \varphi = -0.85 (100\% = 770A)$ -30 -20 -10 10 20 30 40 50 60 T_{inlet} [°C]

Analog temperature sensor output $V_{\text{Theta NTC}}$ Sensing NTC of heatsink

 $Z_{\text{th,ha}}$ - thermal impedance heatsink to ambient per switch nom. cooling conditions





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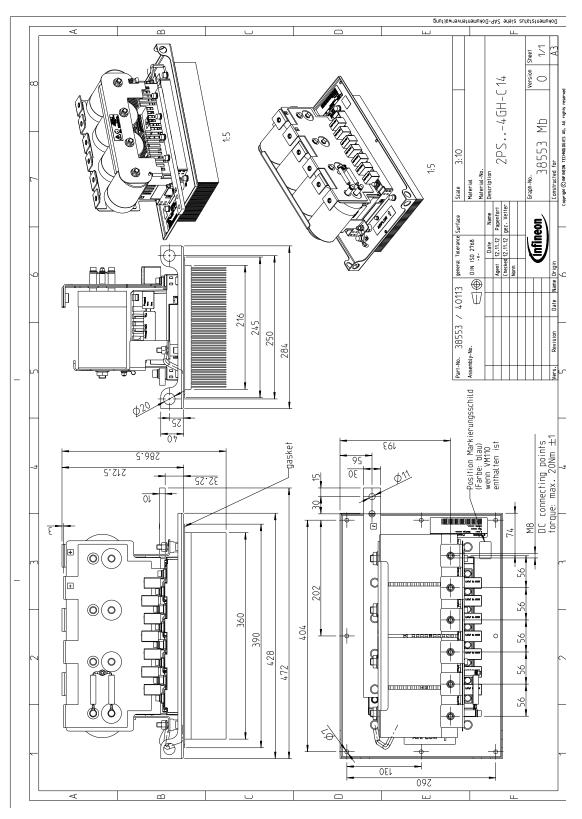
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Mechanical drawing



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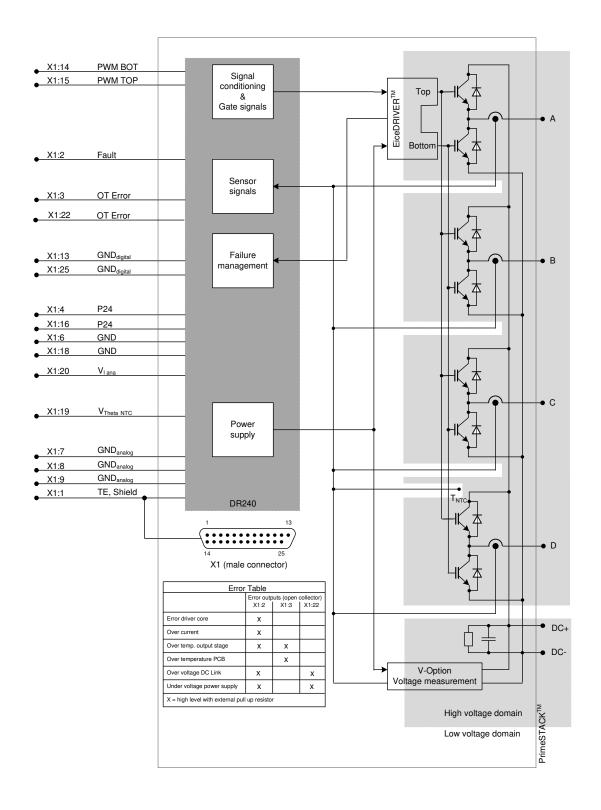
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Circuit diagram



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